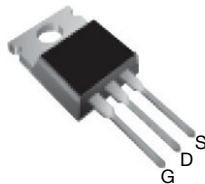


Power MOSFET

TO-220AB


N-Channel MOSFET

PRODUCT SUMMARY

| | | |
|---------------------------|------------------------|------|
| V_{DS} (V) | 200 | |
| $R_{DS(on)}$ (Ω) | $V_{GS} = 10\text{ V}$ | 0.18 |
| Q_g (Max.) (nC) | 70 | |
| Q_{gs} (nC) | 13 | |
| Q_{gd} (nC) | 39 | |
| Configuration | Single | |

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization:
for definitions of compliance please see
www.vishay.com/doc?99912



Available
RoHS*
Available
HALOGEN
FREE
Available

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION

| | |
|---------------------------------|---------------|
| Package | TO-220AB |
| Lead (Pb)-free | IRF640PbF |
| Lead (Pb)-free and halogen-free | IRF640PbF-BE3 |

ABSOLUTE MAXIMUM RATINGS ($T_C = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

| PARAMETER | SYMBOL | LIMIT | UNIT |
|---|------------------|-------------------------------------|-----------------------|
| Drain-source voltage | V_{DS} | 200 | V |
| Gate-source voltage | V_{GS} | ± 20 | |
| Continuous drain current | V_{GS} at 10 V | $T_C = 25\text{ }^{\circ}\text{C}$ | A |
| | | $T_C = 100\text{ }^{\circ}\text{C}$ | |
| Pulsed drain current ^a | I_{DM} | 72 | |
| Linear derating factor | | 1.0 | W/ $^{\circ}\text{C}$ |
| Single pulse avalanche energy ^b | E_{AS} | 580 | mJ |
| Repetitive avalanche current ^a | I_{AR} | 18 | A |
| Repetitive avalanche energy ^a | E_{AR} | 13 | mJ |
| Maximum power dissipation | P_D | 125 | W |
| Peak diode recovery dV/dt ^c | dV/dt | 5.0 | V/ns |
| Operating junction and storage temperature range | T_J, T_{stg} | -55 to +150 | $^{\circ}\text{C}$ |
| Soldering recommendations (peak temperature) ^d | For 10 s | 300 | |
| Mounting torque | 6-32 or M3 screw | 10 | lbf · in |
| | | 1.1 | N · m |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. $V_{DD} = 50\text{ V}$, starting $T_J = 25\text{ }^{\circ}\text{C}$, $L = 2.7\text{ mH}$, $R_{\theta} = 25\text{ }^{\circ}\text{C/W}$, $I_{AS} = 18\text{ A}$ (see fig. 12)

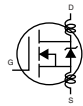

c. $I_{SD} \leq 18\text{ A}$, $dI/dt \leq 150\text{ A}/\mu\text{s}$, $V_{DD} \leq V_{DS}$, $T_J \leq 150\text{ }^{\circ}\text{C}$

d. 1.6 mm from case

THERMAL RESISTANCE RATINGS

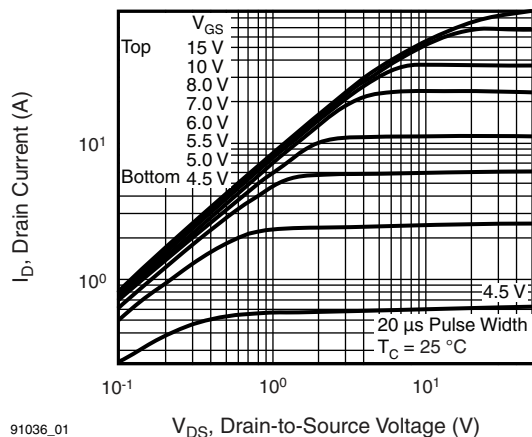
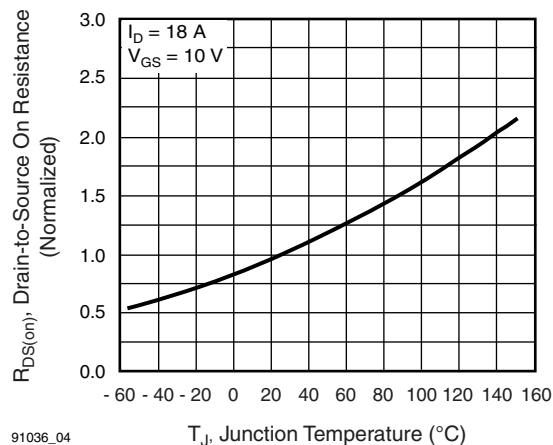
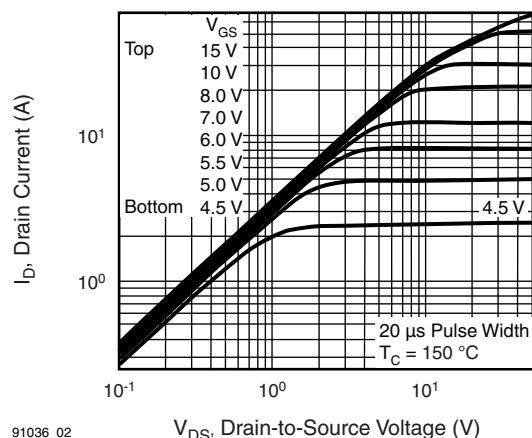
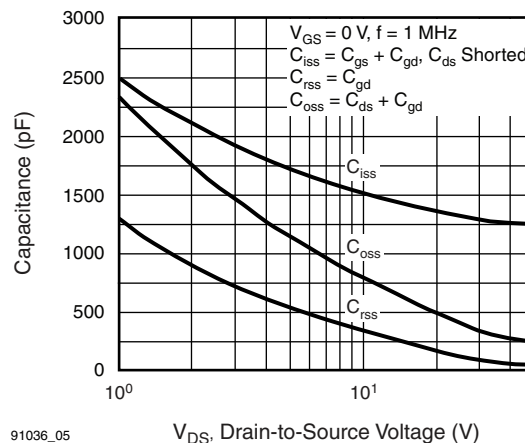
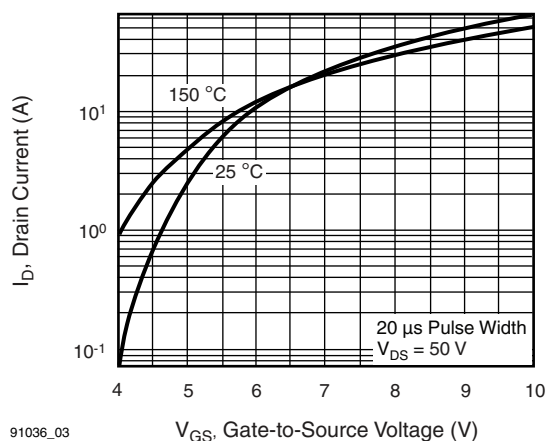
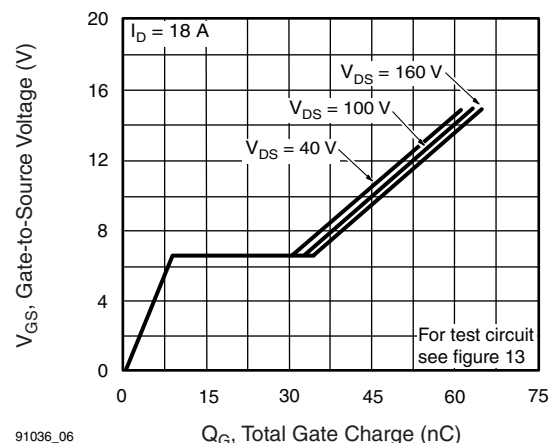
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
|-------------------------------------|------------|------|------|------|
| Maximum junction-to-ambient | R_{thJA} | - | 62 | °C/W |
| Case-to-sink, flat, greased surface | R_{thCS} | 0.50 | - | |
| Maximum junction-to-case (drain) | R_{thJC} | - | 1.0 | |

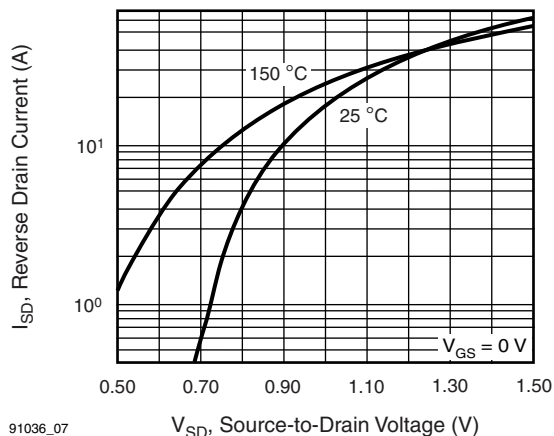
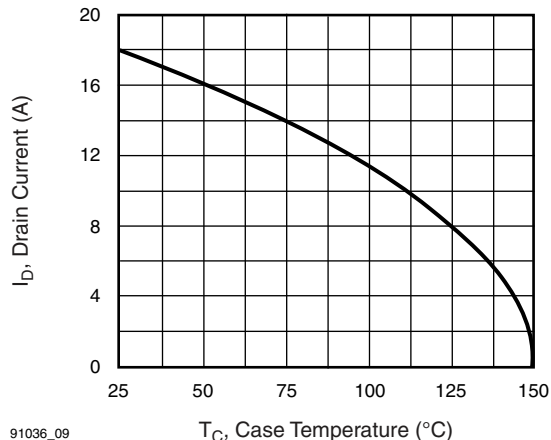
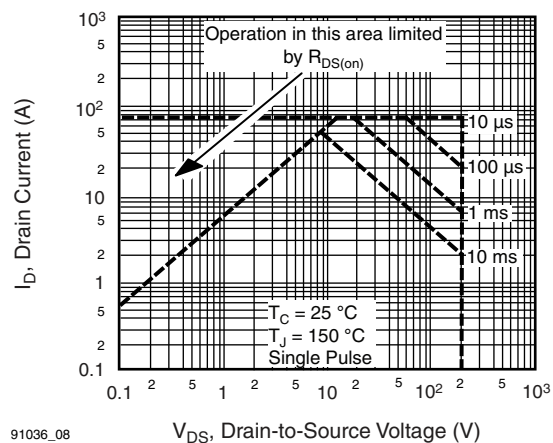
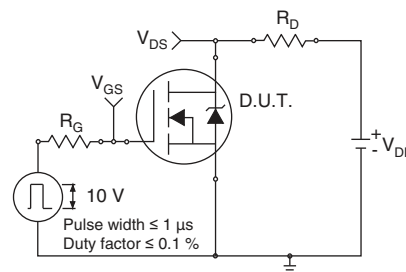
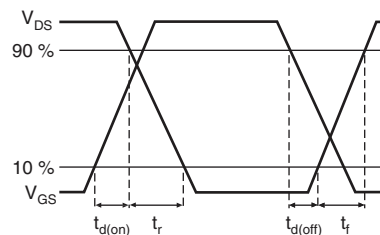
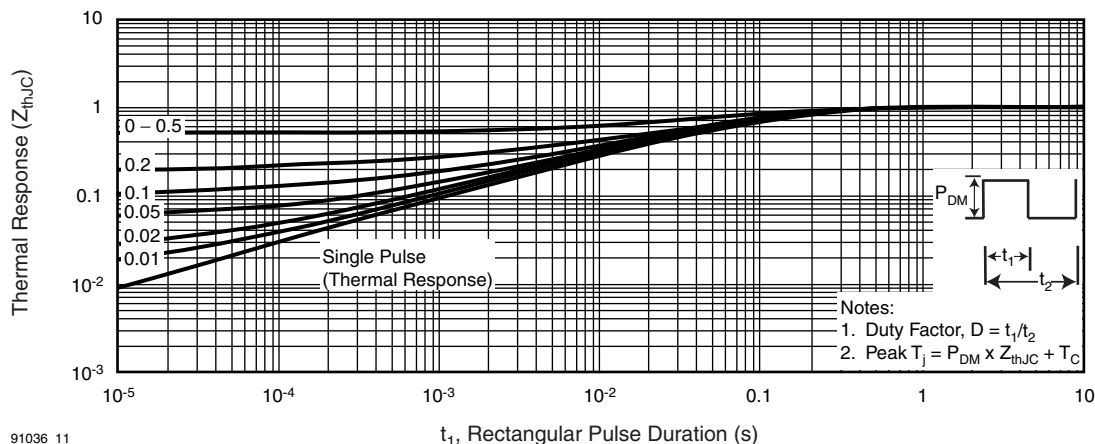
SPECIFICATIONS ($T_J = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

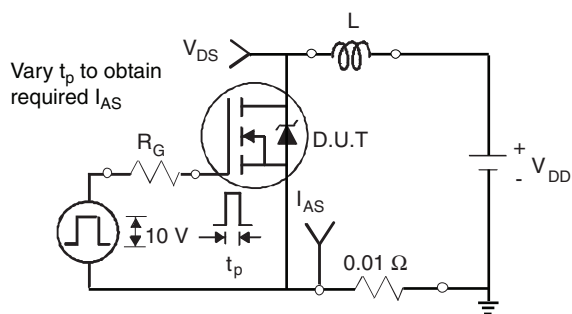
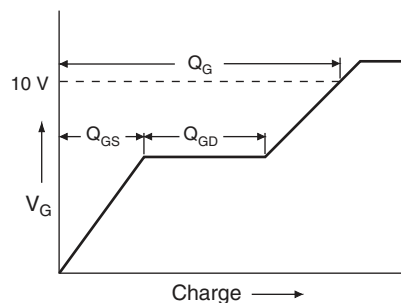
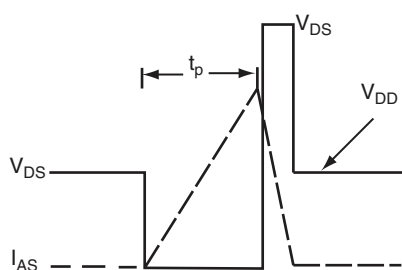
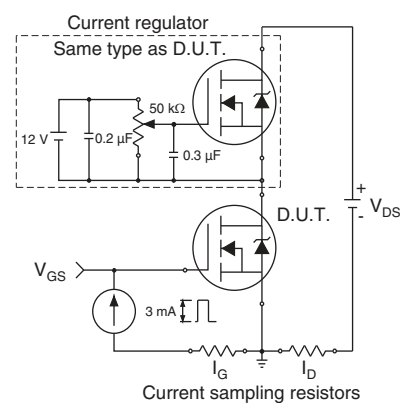
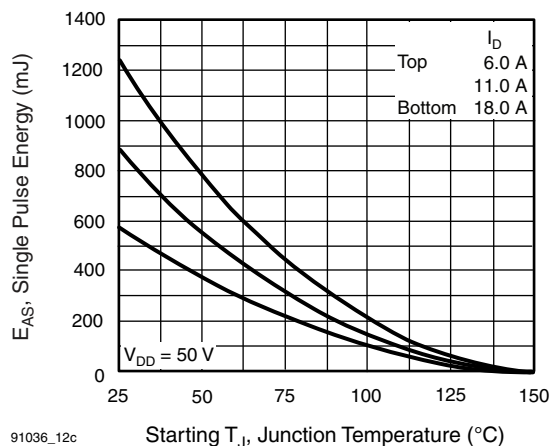
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--|---------------------|---|------|------|-----------|---------------|
| Static | | | | | | |
| Drain-source breakdown voltage | V_{DS} | $V_{GS} = 0\text{ V}$, $I_D = 250\text{ }\mu\text{A}$ | 200 | - | - | V |
| V_{DS} temperature coefficient | $\Delta V_{DS}/T_J$ | Reference to $25\text{ }^{\circ}\text{C}$, $I_D = 1\text{ mA}$ | - | 0.29 | - | V/°C |
| Gate-source threshold voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}$, $I_D = 250\text{ }\mu\text{A}$ | 2.0 | - | 4.0 | V |
| Gate-source leakage | I_{GSS} | $V_{GS} = \pm 20\text{ V}$ | - | - | ± 100 | nA |
| Zero gate voltage drain current | I_{DSS} | $V_{DS} = 200\text{ V}$, $V_{GS} = 0\text{ V}$ | - | - | 25 | μA |
| | | $V_{DS} = 160\text{ V}$, $V_{GS} = 0\text{ V}$, $T_J = 125\text{ }^{\circ}\text{C}$ | - | - | 250 | |
| Drain-source on-state resistance | $R_{DS(on)}$ | $V_{GS} = 10\text{ V}$, $I_D = 11\text{ A}^b$ | - | - | 0.18 | Ω |
| Forward transconductance | g_{fs} | $V_{DS} = 50\text{ V}$, $I_D = 11\text{ A}^b$ | 6.7 | - | - | S |
| Dynamic | | | | | | |
| Input capacitance | C_{iss} | $V_{GS} = 0\text{ V}$, $V_{DS} = 25\text{ V}$, $f = 1.0\text{ MHz}$, see fig. 5 | - | 1300 | - | pF |
| Output capacitance | C_{oss} | | - | 430 | - | |
| Reverse transfer capacitance | C_{rss} | | - | 130 | - | |
| Total gate charge | Q_g | $V_{GS} = 10\text{ V}$, $I_D = 18\text{ A}$, $V_{DS} = 160\text{ V}$, see fig. 6 and 13 ^b | - | - | 70 | nC |
| Gate-source charge | Q_{gs} | | - | - | 13 | |
| Gate-drain charge | Q_{gd} | | - | - | 39 | |
| Turn-on delay time | $t_{d(on)}$ | $V_{DD} = 100\text{ V}$, $I_D = 18\text{ A}$, $R_g = 9.1\text{ }\Omega$, $R_D = 5.4\text{ }\Omega$, see fig. 10 ^b | - | 14 | - | ns |
| Rise time | t_r | | - | 51 | - | |
| Turn-off delay time | $t_{d(off)}$ | | - | 45 | - | |
| Fall time | t_f | | - | 36 | - | |
| Gate input resistance | L_D | Between lead, 6 mm (0.25") from package and center of die contact  | - | 4.5 | - | nH |
| Internal drain inductance | L_S | | - | 7.5 | - | |
| Internal source inductance | R_g | $f = 1\text{ MHz}$, open drain | 0.5 | - | 3.6 | Ω |
| Drain-Source Body Diode Characteristics | | | | | | |
| Continuous source-drain diode current | I_S | MOSFET symbol showing the integral reverse p - n junction diode  | - | - | 18 | A |
| Pulsed diode forward current ^a | I_{SM} | | - | - | 72 | |
| Body diode voltage | V_{SD} | $T_J = 25\text{ }^{\circ}\text{C}$, $I_S = 18\text{ A}$, $V_{GS} = 0\text{ V}^b$ | - | - | 2.0 | V |
| Body diode reverse recovery time | t_{rr} | $T_J = 25\text{ }^{\circ}\text{C}$, $I_F = 18\text{ A}$, $dI/dt = 100\text{ A}/\mu\text{s}^b$ | - | 300 | 610 | ns |
| Body diode reverse recovery charge | Q_{rr} | | - | 3.4 | 7.1 | μC |
| Forward turn-on time | t_{on} | Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D) | | | | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
b. Pulse width $\leq 300\text{ }\mu\text{s}$; duty cycle $\leq 2\text{ }\%$

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 1 - Typical Output Characteristics, $T_C = 25^\circ\text{C}$

Fig. 4 - Normalized On-Resistance vs. Temperature

Fig. 2 - Typical Output Characteristics, $T_C = 150^\circ\text{C}$

Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

Fig. 3 - Typical Transfer Characteristics

Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage


Fig. 7 - Typical Source-Drain Diode Forward Voltage

Fig. 9 - Maximum Drain Current vs. Case Temperature

Fig. 8 - Maximum Safe Operating Area

Fig. 10a - Switching Time Test Circuit

Fig. 10b - Switching Time Waveforms

Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 13a - Basic Gate Charge Waveform

Fig. 12b - Unclamped Inductive Waveforms

Fig. 13b - Gate Charge Test Circuit


91036_12c

Fig. 12c - Maximum Avalanche Energy vs. Drain Current

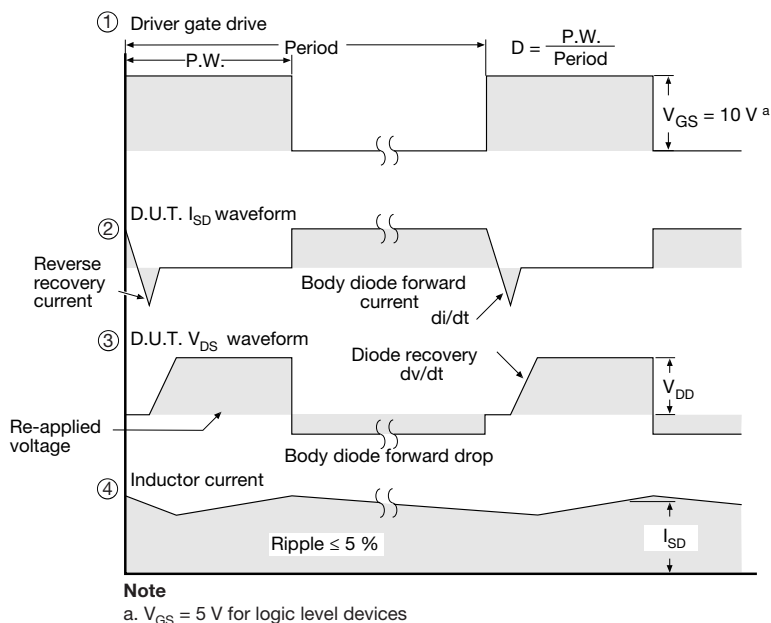
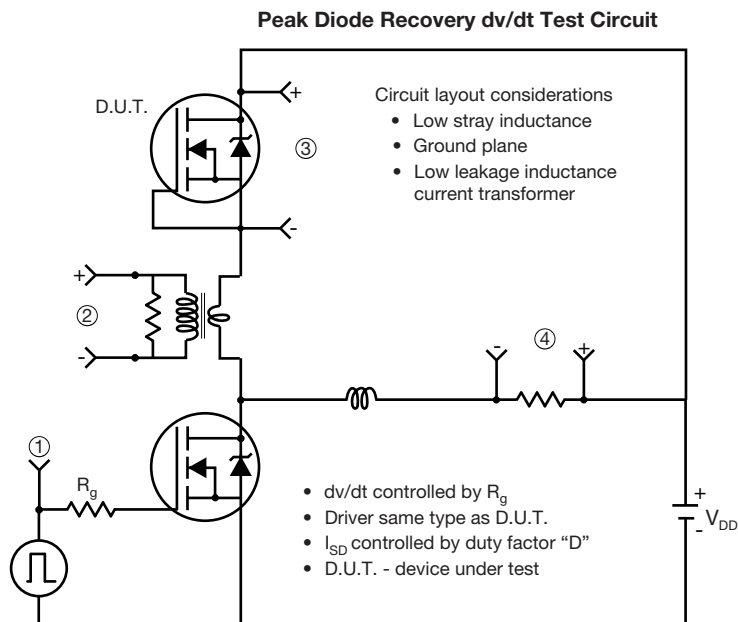


Fig. 14 - For N-Channel

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